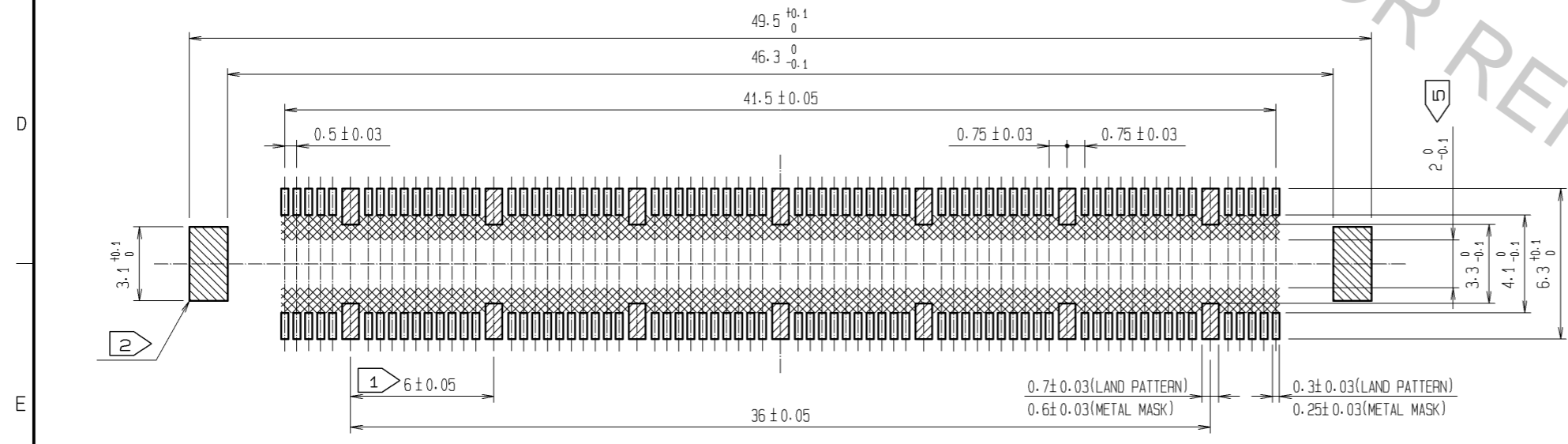


RECOMMENDED LAND PATTERN DIMENSION OF PCB  
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



- NOTES
- ① 14 HATCHED PARTS: GROUND CIRCUIT.
  - ② 2 HATCHED PARTS: GROUND CIRCUIT.
  - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
  - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
  - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
  - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

2	PHOSPHOR BRONZE	TIN-PLATING	4	PHOSPHOR BRONZE	TIN-PLATING			
1	LCP	BEIGE UL94V-0	3	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1µm min. LEAD AREA: TIN-PLATING 1µm min. UNDER PLATING: NICKEL 1µm min.			
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS	
UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
mm		4 : 1	△	APPROVED : HS. OKAWA	08.06.26	DRAWING NO. EDC3-151967-25		
<b>HRS</b> HIROSE ELECTRIC CO., LTD.		CHECED : HT. YAMAGUCHI	08.06.25	PART NO. FX10B-140P/14-SV1(71)				
		DESIGNED : SY. KAMIGA	08.06.23	CODE NO. CL570-0124-5-71				
		DRAWN : HK. SUNADORI	08.06.17					